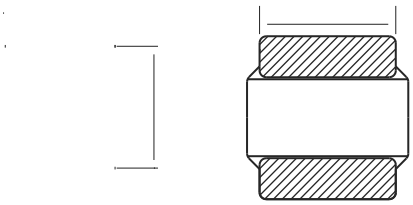
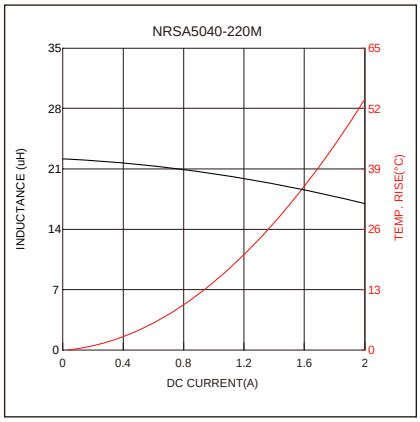
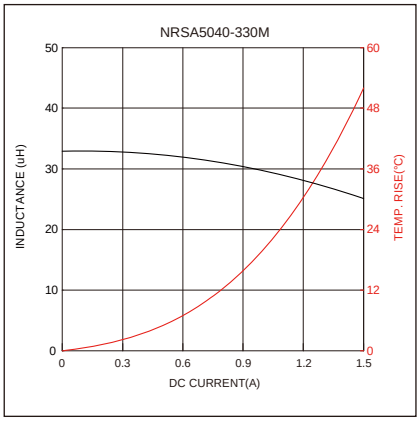
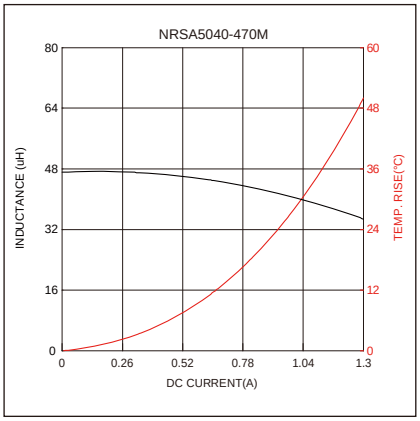
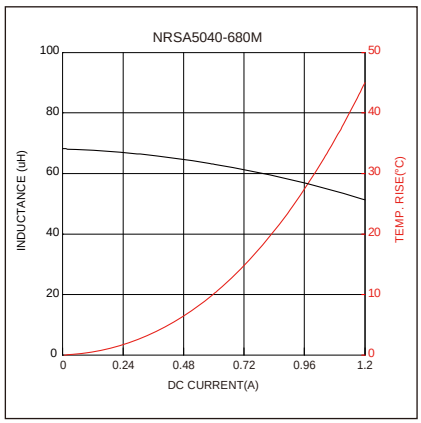
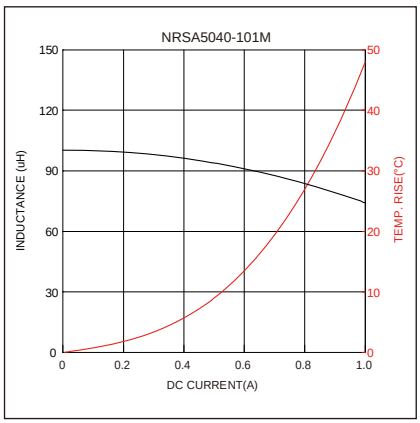


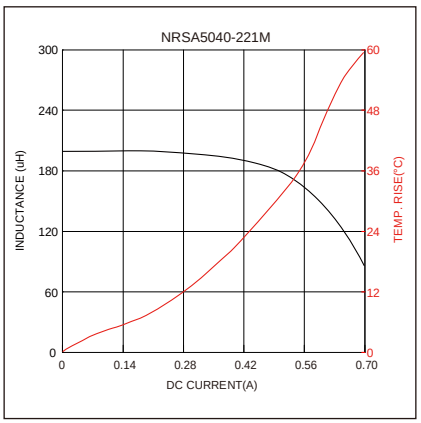

NRSA5040-220M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
35
28
21
14
7
0
65
52
39
26
13
0
0
0.4
0.8
1.2
1.6
2


NRSA5040-330M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
50
40
30
20
10
0
60
48
36
24
12
0
0
0.3
0.6
0.9
1.2
1.5


NRSA5040-470M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
80
64
48
32
16
0
60
48
36
24
12
0
0
0.26
0.52
0.78
1.04
1.3


NRSA5040-680M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
100
80
60
40
20
0
50
40
30
20
10
0
0
0.24
0.48
0.72
0.96
1.2


NRSA5040-101M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
150
120
90
60
30
0
50
40
30
20
10
0
0
0.2
0.4
0.6
0.8
1.0


NRSA5040-221M
INDUCTANCE (uH)
TEMP. RISE(°C)
DC CURRENT(A)
300
240
180
120
60
0
60
48
36
24
12
0
0
0.14
0.28
0.42
0.56
0.70

Soldering Reflow:

Preheat condition: 150 ~200℃/ 60~120 sec.

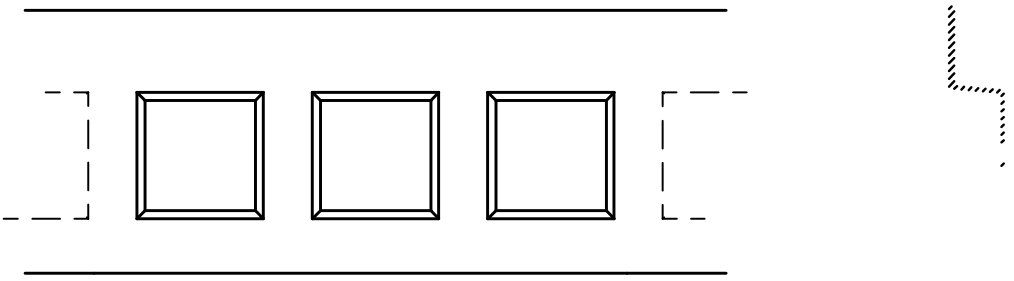
Allowed time above 217℃: 60~90 sec.

Max temperature: 260℃.

Allowed Reflow time: 2x max.

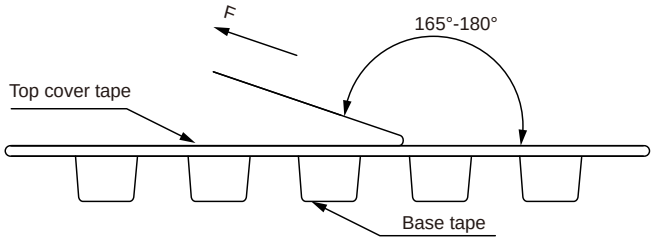
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
NRSA5040	5.3±0.1	5.3±0.1	1.5±0.1	4.0±0.1	8.0±0.1	12.0±0.3	4.2±0.1	1.75±0.1	0.40±0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.3 to 1.17 N

Reel Dimension：[mm]

Packaging Quantity: